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**IEEE P802.11  
Wireless LANs**

**Minutes of High Throughput Study Group Meetings**

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September 11, 13, 2002

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**Abstract**

Minutes of the High Throughput Study Group meetings held during the IEEE 802.11/15 Interim meeting in Monterey from Sept 09 through 13, 2002.

**Executive Summary:**

1. Inaugural meeting of the High Throughput Study Group was held on Wednesday 9-11-02, 3:30 to 5:30 PM; attendance was excellent (>100) indicating high interest
2. Garth Hillman was affirmed as secretary.
3. Straw polls indicated that the scope should include:
  - a. Enhancements to both existing and planned 802.11 extensions
  - b. Throughput improvement expected should be quantified
4. Scope statement – ‘To define standardized modifications to the 802.11 MAC and PHY layers that achieve a minimum increase of at least xxx in throughput as measured at the MAC data SAP’ - was developed for the PAR
5. Purpose statement developed – ‘To improve the 802.11 wireless LAN user experience by providing significantly higher throughput for current applications and to enable new applications and market segments’ - was developed for the PAR
6. Jon’s meeting Doc. is 11-02/532r0

Attendance List:

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Submission

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